# HN462532

## 4096-word $\times$ 8-bit UV Erasable and Programmable Read Only Memory

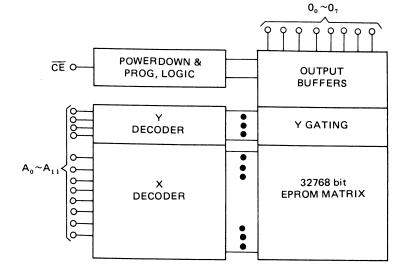
The HN462532 is a 4096 word by 8 bit erasable and electrically programmable ROM. This device is packaged in a 24-pin, dual-in-line package with transparent lid. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern, whereby a new pattern can then be written into the device.

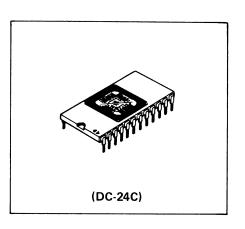
FEATURES

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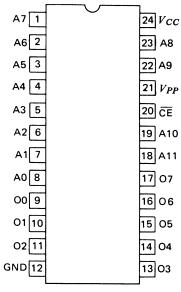
- Single Power Supply ..... +5V ±5%
  - Simple Programming ..... Program Voltage: +25V D.C. Program with One 50ms Pulse
- Static . . . . . . . . . . . . . No Clocks Required
- Inputs and Outputs TTL Compatible During Both Read and Program Modes
- Fully Decoded On-Chip Address Decode
- Access Time . . . . . . . . . . . . . . . 450ns (Max.)
- Low Power Dissipation . . . . . 858mW (Max.) Active Power 201mW (Max.) Standby Power
  Three State Output . . . . . . OR-Tie Capability
- Compatible with TMS2532
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## BLOCK DIAGRAM





#### PIN ARRANGEMENT



(Top View)



## MODE SELECTION

Pins	CE (20)	V <sub>PP</sub> (21)	V <sub>CC</sub> (24)	Outputs (9 to 11, 13 to 17)
Read	VIL	+5	+5	Dout
Stand by	V <sub>IH</sub>	+5	+5	High Z
Program	Pulsed VIH to VIL	+25	+5	Din
Program Inhibit	V <sub>IH</sub>	+25	+5	High Z

## ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Value	Unit
All Input and Output Voltages*	V <sub>IN</sub> , V <sub>out</sub>	-0.3 to +7	V
VPP Voltage*	V <sub>PP</sub>	-0.3 to +28	V
Operating Temperature Range	Topr	0 to +70	°C
Storage Temperature Range	T <sub>stg</sub>	65 to +125	°C

\*with respect to GND.

## READ OPERATION

## • D.C. AND OPERATING CHARACTERISTICS ( $T_a = 0 \text{ to } + 70^{\circ}\text{C}$ , $V_{CC} = 5\text{V} \pm 5\%$ , $V_{PP} = V_{CC} \pm 0.6\text{V}$ )

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Input Leakage Current	I <sub>LI</sub>	Vin = 5.25 V		-	10	μA
Output Leakage Current	ILO	$V_{out} = 5.25 \vee / 0.4 \vee$	-	-	10	μA
VPP Current	IPP1	<i>Vpp</i> = 5.85 V	-	-	12	mA
Vcc Current (Standby)	Icc1	$\overline{CE} = V_{IH}$	-	-	25	mA
VCC Current (Active)	Icc2	$\overline{CE} = V_{IL}$	-	-	150	mA
Input Low Voltage	V <sub>IL</sub>		-0.1	-	0.8	V
Input High Voltage	V <sub>IH</sub>		2.0	-	<i>V</i> <sub>CC</sub> +1	V
Output Low Voltage	Vol	<i>I</i> <sub>OL</sub> = 2.1 mA	-	-	0.4	V
Output High Voltage	Voh	$I_{OH} = -400 \mu A$	2.4	-	-	V

Notes: Vcc must be applied simultaneously or before Vpp and removed simultaneously or after Vpp.

## • AC CHARACTERISTICS ( $T_a = 0 \text{ to } + 70^{\circ}\text{C}$ , $V_{CC} = 5\text{V} \pm 5\%$ , $V_{PP} = V_{CC} \pm 0.6 \text{V}$ )

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Address to Output Delay	tACC	$\overline{CE} = V_{IL}$	-	-	450	ns
CE to Output Delay	t <sub>CE</sub>		_	-	450	ns
CE High to Output Float	t <sub>DF</sub>		0	_	100	ns
Address to Output Hold	t <sub>OH</sub>	$\overline{CE} = V_{IL}$	0		_	ns



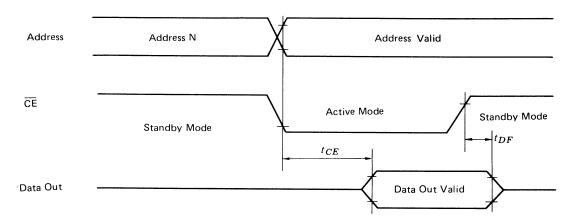
## HN462532

#### • SWITCHING CHARACTERISTICS

**Test Conditions** 

Input Pulse Levels: Input Rise and Fall Times: Output Load: Reference Level for Measuring Timing:

0.8V to 2.2V ≤20ns 1TTL Gate + 100pF Inputs; 1V and 2V, Outputs; 0.8V and 2V



## • **CAPACITANCE** ( $T_a = 25^{\circ}C, f = 1 \text{ MHz}$ )

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Input Capacitance	Cin	$V_{in} = 0 V$			6	pF
Output Capacitance	Cout	$V_{out} = 0V$	-	-	12	pF

## PROGRAMMING OPERATION

## • DC PROGRAMMING CHARACTERISTICS ( $T_a = 25^{\circ}C \pm 5^{\circ}C$ , $V_{CC} = 5V \pm 5\%$ , $V_{PP} = 25V \pm 1V$ )

Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Input Leakage Current	ILI	$V_{in} = 5.25 V / 0.4 V$	-	-	10	μA
VPP Supply Current During Programming	IPP2	$\overline{CE} = V_{IL}$	-	-	30	mA
VCC Supply Current	Icc		_	_	150	mA
Input Low Level	VIL		-0.1	_	0.8	v
Input High Level	VIH		2.0	_	Vcc+1	v

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#### • AC PROGRAMMING CHARACTERISTICS ( $T_a = 25^{\circ}C \pm 5^{\circ}C$ , $V_{CC} = 5V \pm 5\%$ , $V_{PP} = 25V \pm 1V$ )

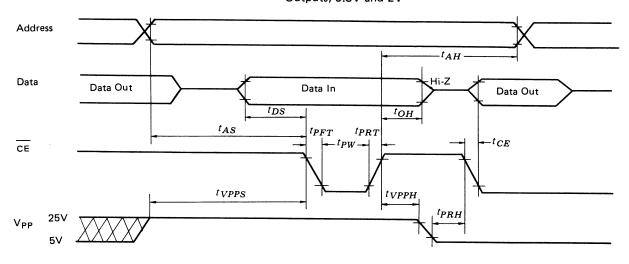
Parameter	Symbol	Test Conditions	min.	typ.	max.	Unit
Address Setup Time	t <sub>AS</sub>		2	_	-	μs
Data Setup Time	t <sub>DS</sub>		2		_	μs
Address Hold Time	t <sub>AH</sub>	······································	2	-	_	μs
Data Hold Time	t <sub>DH</sub>		2	-	_	μs
Setup Time from VPP	tVPPS	······································	0	_	_	ns
Program Pulse Hold Time	t <sub>PRH</sub>		0	_	_	ns
V <sub>PP</sub> Hold Time	t <sub>VPPH</sub>		0	_	_	ns
Program Pulse Width	t <sub>PW</sub>		45	50	55	ms
Program Pulse Time	tPRT		5	_	-	ns
Program Pulse Time	tPFT		5	_		ns

Note: VCC must be applied simultaneously or before VPP and removed simultaneously or after VPP.

#### • SWITCHING CHARACTERISTICS

**Test Conditions** 

Input Pulse Level:	0.8V to 2.2V
Input Rise and Fall Times:	≤20ns
Output Load:	1TTL Gate + 100pF
Reference Level for Measuring Timing:	Inputs; 1V and 2V,
	Outputs; 0.8V and 2V



### •ERASE

Erasure of HN462532 is performed by exposure to ultraviolet light with a wavelength of 2537Å, and all the output data are changed to "1" after this erasure procedure.

The minimum integrated close (i.e., UV intensity x exposure time) for erasure is  $15W \cdot sec/cm^2$ .

